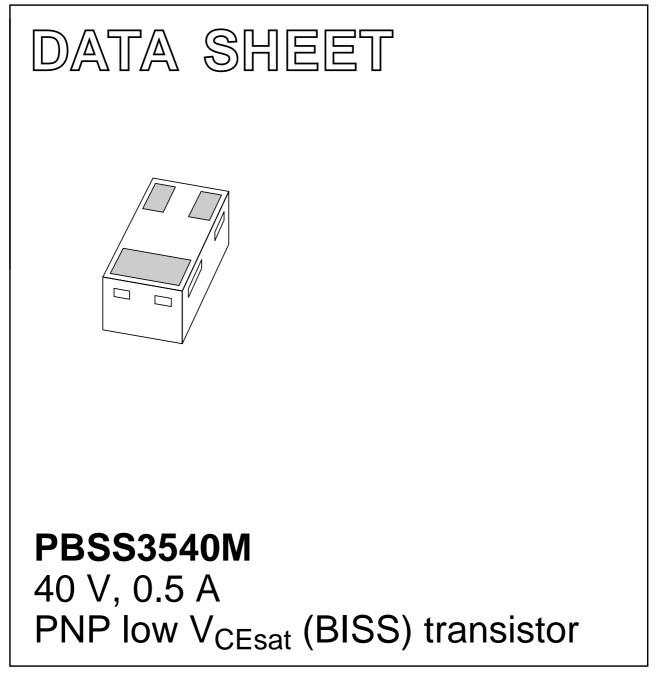
# DISCRETE SEMICONDUCTORS



Product specification

2003 Aug 12



#### **Product specification**

## PBSS3540M

# 40 V, 0.5 A PNP low V<sub>CEsat</sub> (BISS) transistor

#### FEATURES

- Low collector-emitter saturation voltage V<sub>CEsat</sub>
- High collector current capability  $I_{C}$  and  $I_{CM}$
- High efficiency leading to reduced heat generation
- Reduced printed-circuit board requirements.

#### APPLICATIONS

- Power management:
  - DC-DC converter
  - Supply line switching
  - Battery charger
  - LCD backlighting.
- Peripheral driver:
  - Driver in low supply voltage applications (e.g. lamps and LEDs).
  - Inductive load drivers (e.g. relays, buzzers and motors).

#### DESCRIPTION

Low V<sub>CEsat</sub> PNP transistor in a SOT883 leadless ultra small plastic package. NPN complement: PBSS2540M.

#### MARKING

TYPE NUMBER	MARKING CODE		
PBSS3540M	DA		

### QUICK REFERENCE DATA

SYMBOL	PARAMETER	MAX.	UNIT	
V <sub>CEO</sub>	-40	V		
I <sub>C</sub> collector current (DC)		-500	mA	
I <sub>CM</sub> peak collector current		-1	А	
R <sub>CEsat</sub>	R <sub>CEsat</sub> equivalent on-resistance		mΩ	

#### PINNING

PIN	DESCRIPTION	
1	base	
2	emitter	
3	collector	

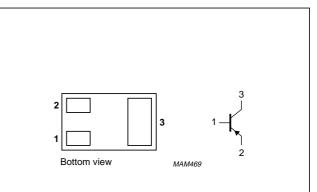


Fig.1 Simplified outline (SOT883) and symbol.

# 40 V, 0.5 A PNP low $V_{CEsat}$ (BISS) transistor

## PBSS3540M

#### LIMITING VALUES

In accordance with the Absolute Maximum Rating System (IEC 60134).

SYMBOL	PARAMETER	PARAMETER CONDITIONS		MAX.	UNIT
V <sub>CBO</sub>	collector-base voltage	ase voltage open emitter –		-40	V
V <sub>CEO</sub>	collector-emitter voltage	open base	-	-40	V
V <sub>EBO</sub>	emitter-base voltage	open collector	-	-6	V
I <sub>C</sub>	collector current (DC)	notes 1 and 2	-	-500	mA
I <sub>CM</sub>	peak collector current		-	-1	A
I <sub>BM</sub>	peak base current		-	-100	mA
P <sub>tot</sub>	total power dissipation	$T_{amb} \le 25 \ ^{\circ}C$ ; notes 1 and 2	-	250	mW
		$T_{amb} \le 25 \ ^{\circ}C$ ; note 1 and 3	-	430	mW
T <sub>stg</sub>	storage temperature		-65	+150	°C
Tj	junction temperature		-	150	°C
T <sub>amb</sub>	operating ambient temperature		-65	+150	°C

#### Notes

- 1. Refer to SOT883 standard mounting conditions.
- Device mounted on an FR4 printed-circuit board, single-sided copper, tinplated, standard footprint, with 60 μm copper strip line.
- 3. Device mounted on a printed-circuit board, single-sided copper, tinplated, mounting pad for collector 1 cm<sup>2</sup>.

#### THERMAL CHARACTERISTICS

SYMBOL	BOL PARAMETER CONDITIONS		VALUE	UNIT
R <sub>th j-a</sub>	thermal resistance from junction to	in free air; notes 1 and 2	500	K/W
	ambient	in free air; notes 1, 3 and 4	290	K/W

#### Notes

- 1. Refer to SOT883 standard mounting conditions.
- Device mounted on an FR4 printed-circuit board, single-sided copper, tinplated, standard footprint, with 60 μm copper strip line.
- 3. Device mounted on a printed-circuit board, single-sided copper, tinplated, mounting pad for collector 1 cm<sup>2</sup>.
- 4. Operated under pulsed conditions: duty cycle  $\delta$   $\leq$  20%, pulse width  $t_p$   $\leq$  30 ms.

#### Soldering

Reflow soldering is the only recommended soldering method.

# 40 V, 0.5 A PNP low V<sub>CEsat</sub> (BISS) transistor

## PBSS3540M

#### CHARACTERISTICS

 $T_{amb}$  = 25 °C unless otherwise specified.

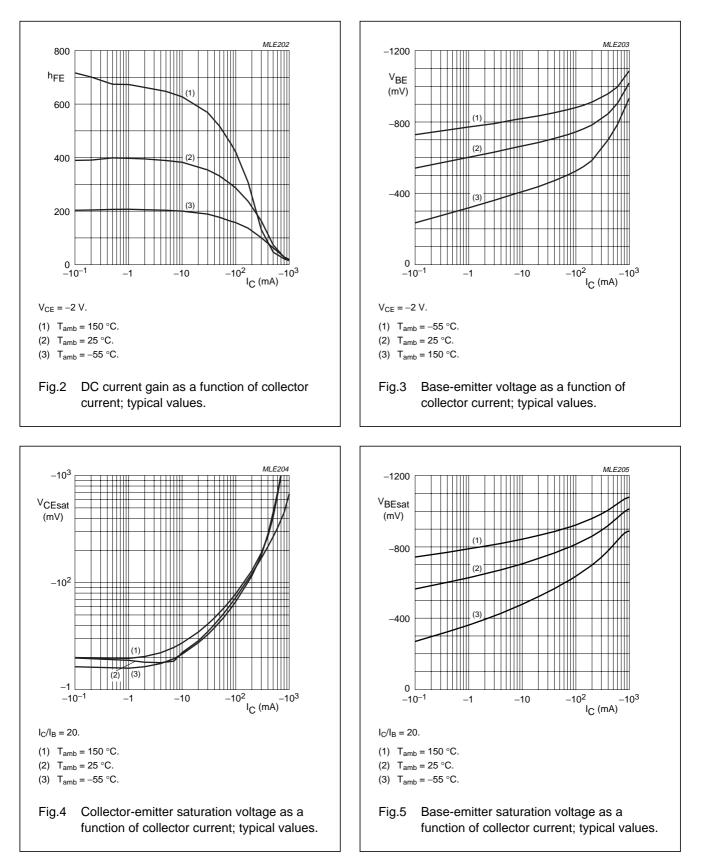
SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
I <sub>CBO</sub>	collector-base cut-off current	$V_{CB} = -30 \text{ V}; \text{ I}_{E} = 0$	-	-	-100	nA
		$V_{CB} = -30 \text{ V}; I_E = 0; T_j = 150 \text{ °C}$	-	-	-50	μA
I <sub>EBO</sub>	emitter-base cut-off current	$V_{EB} = -5 \text{ V}; \text{ I}_{C} = 0$	-	-	-100	nA
h <sub>FE</sub>	DC current gain	$V_{CE} = -2 \text{ V}; I_C = -10 \text{ mA}$	200	-	-	
		$V_{CE} = -2 \text{ V}; I_{C} = -100 \text{ mA}; \text{ note } 1$	150	-	-	
		$V_{CE} = -2 \text{ V}; I_{C} = -500 \text{ mA}; \text{ note } 1$	40	-	-	
V <sub>CEsat</sub>	collector-emitter saturation voltage	$I_{\rm C} = -10 \text{ mA}; I_{\rm B} = -0.5 \text{ mA}$	-	-	-50	mV
		I <sub>C</sub> = -100 mA; I <sub>B</sub> = -5 mA	-	-	-130	mV
		$I_{\rm C} = -200 \text{ mA}; I_{\rm B} = -10 \text{ mA}$	-	-	-200	mV
		$I_{C} = -500 \text{ mA}; I_{B} = -50 \text{ mA}; \text{ note } 1$	-	-	-350	mV
R <sub>CEsat</sub>	equivalent on-resistance	$I_{C} = -500 \text{ mA}; I_{B} = -50 \text{ mA}; \text{ note 1}$	-	440	<700	mΩ
V <sub>BEsat</sub>	base-emitter saturation voltage	$I_{C} = -500 \text{ mA}; I_{B} = -50 \text{ mA}; \text{ note 1}$	-	-	-1.2	V
V <sub>BEon</sub>	base-emitter turn-on voltage	$V_{CE} = -2 \text{ V}; I_{C} = -100 \text{ mA}; \text{ note } 1$	-	-	-1.1	V
f <sub>T</sub>	transition frequency	$I_{C} = -100 \text{ mA}; V_{CE} = -5 \text{ V};$ f = 100 MHz	100	300	-	MHz
Cc	collector capacitance	$V_{CB} = -10 \text{ V}; I_E = I_e = 0; f = 1 \text{ MHz}$	-	_	10	pF

#### Note

1. Pulse test:  $t_p \le 300 \ \mu s; \ \delta \le 0.02$ .

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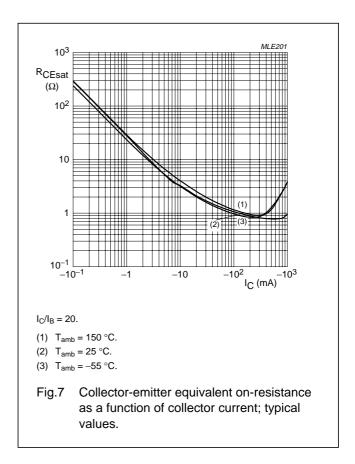
# PBSS3540M



PBSS3540M

# 40 V, 0.5 A PNP low V<sub>CEsat</sub> (BISS) transistor

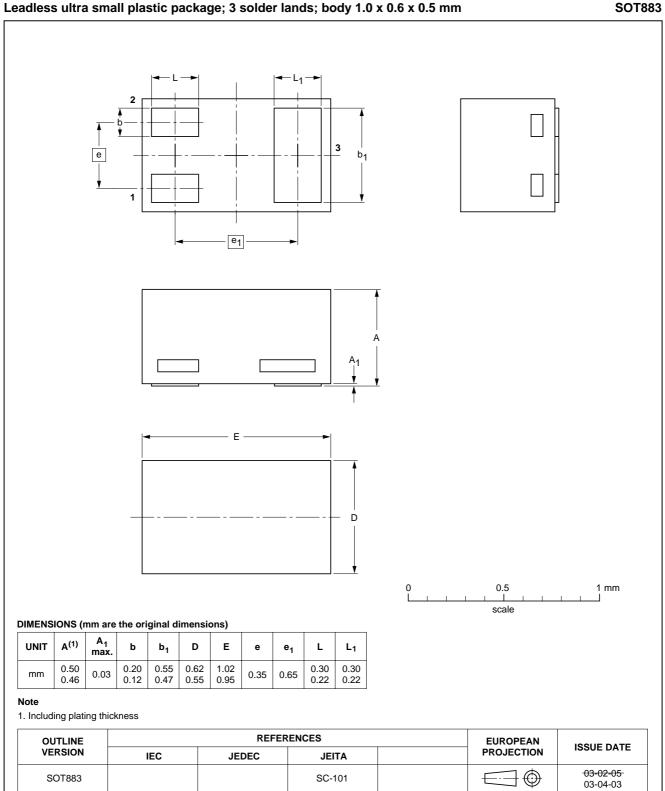
#### MLE200 -1200 ΙC (mA) (1) .(4 -800 (6) . (8) .(9) (10) -400 0 $^{-4}$ V<sub>CE</sub> (V) $^{-5}$ 0 -1 -2 -3 $T_{amb} = 25 \ ^{\circ}C.$ (1) $I_B = -40 \text{ mA}.$ (5) $I_B = -24 \text{ mA}.$ (9) $I_B = -8 \text{ mA}.$ (2) $I_B = -36 \text{ mA}.$ (6) $I_B = -20 \text{ mA}.$ (10) $I_B = -4 \text{ mA}.$ (3) $I_B = -32 \text{ mA}.$ (7) $I_B = -16 \text{ mA}.$ (4) $I_B = -28 \text{ mA}.$ (8) $I_B = -12 \text{ mA}.$ Fig.6 Collector current as a function of collector-emitter voltage; typical values.



PBSS3540M

# 40 V, 0.5 A PNP low V<sub>CEsat</sub> (BISS) transistor

### PACKAGE OUTLINE



**SOT883** 

# 40 V, 0.5 A PNP low $V_{CEsat}$ (BISS) transistor

### DATA SHEET STATUS

LEVEL	DATA SHEET STATUS <sup>(1)</sup>	PRODUCT STATUS <sup>(2)(3)</sup>	DEFINITION
1	Objective data	Development	This data sheet contains data from the objective specification for product development. Philips Semiconductors reserves the right to change the specification in any manner without notice.
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For additional information please visit http://www.semiconductors.philips.com. Fax: +31 40 27 24825 For sales offices addresses send e-mail to: sales.addresses@www.semiconductors.philips.com.

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Printed in The Netherlands

613514/01/pp9

Date of release: 2003 Aug 12

Document order number: 9397 750 11561

SCA75

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